

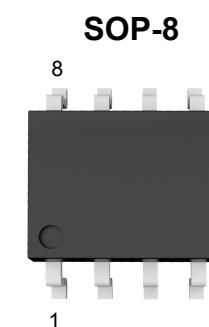


PJM05P30PA

P-Channel Enhancement Mode Power MOSFET

Features

- High density cell design for ultra low $R_{DS(on)}$
- Advanced trench technology
- $V_{DS} = -30V, I_D = -5.1A$
- $R_{DS(on)} < 55m\Omega @ V_{GS} = -10V$

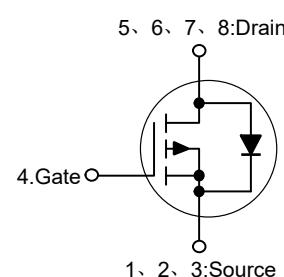


Marking code: 9435

Applications

- PWM applications
- Load switch
- Power management

Schematic Diagram



Absolute Maximum Ratings

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$-V_{DS}$	30	V
Gate-Source Voltage	$-V_{GS}$	± 20	V
Drain Current-Continuous	$-I_D$	5.1	A
Drain Current-Pulsed ^{Note1}	$-I_{DM}$	20.4	A
Maximum Power Dissipation	P_D	2.15	W
Junction Temperature	T_J	150	°C
Storage Temperature Range	T_{STG}	-55 to +150	°C

Thermal Characteristics

Thermal Resistance, Junction-to-Ambient ^{Note2}	$R_{\theta JA}$	58	°C/W
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Electrical Characteristics

(Ta=25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	-V _{(BR)DSS}	V _{GS} =0V, I _D =-250μA	30	--	--	V
Zero Gate Voltage Drain Current	-I _{DSS}	V _{DS} =-30V, V _{GS} =0V	--	--	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
Gate Threshold Voltage ^{Note3}	-V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	1	1.5	2.5	V
Drain-Source On-Resistance ^{Note3}	R _{DS(on)}	V _{GS} =-10V, I _D =-5.1A	--	43	55	mΩ
		V _{GS} =-4.5V, I _D =-4.2A	--	65	90	mΩ
Forward Transconductance ^{Note3}	g _{FS}	V _{DS} =-5V, I _D =-4A	--	7.5	--	S
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} =-15V, V _{GS} =0V, f=1MHz	--	596	--	pF
Output Capacitance	C _{oss}		--	95	--	pF
Reverse Transfer Capacitance	C _{rss}		--	68	--	pF
Switching Characteristics						
Turn-on Delay Time	t _{d(on)}	V _{DD} =-15V, V _{GS} =-10V I _D =-1A, R _{GEN} =2.5Ω	--	14	--	nS
Turn-on Rise Time	t _r		--	61	--	nS
Turn-off Delay Time	t _{d(off)}		--	19	--	nS
Turn-off Fall Time	t _f		--	10	--	nS
Total Gate Charge	Q _g	V _{DS} =-15V, V _{GS} =-10V I _D =-5.1A	--	6.8	--	nC
Gate-Source Charge	Q _{gs}		--	1	--	nC
Gate-Drain Charge	Q _{gd}		--	1.4	--	nC
Source-Drain Diode Characteristics						
Diode Forward Voltage ^{Note3}	-V _{SD}	V _{GS} =0V, I _S =-5.1A	--	0.8	1.2	V
Diode Forward Current ^{Note2}	-I _S		--	--	5.1	A

Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t ≤ 10 sec.

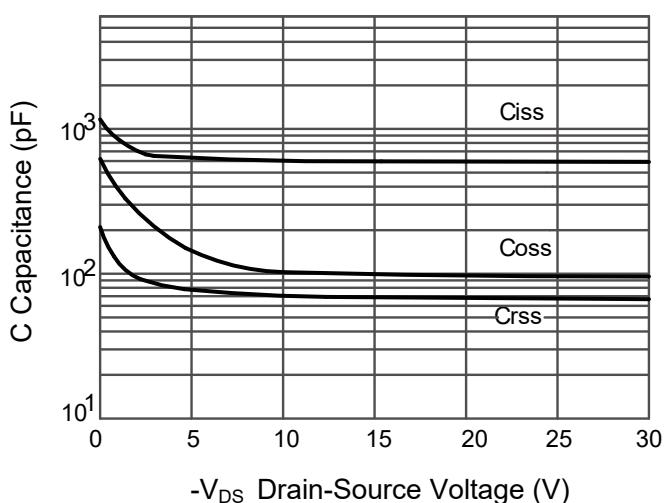
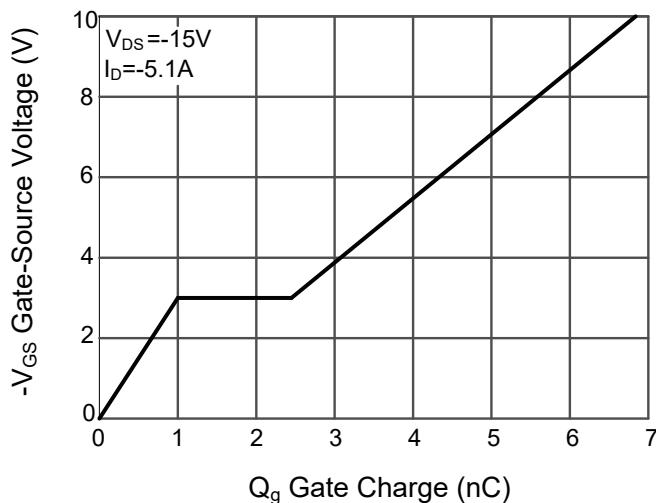
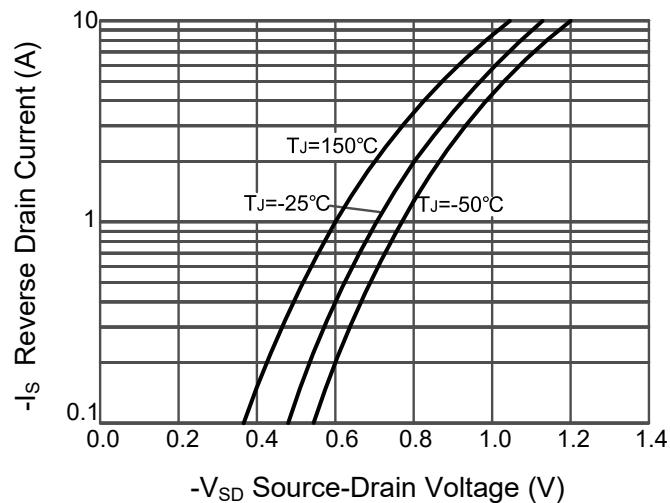
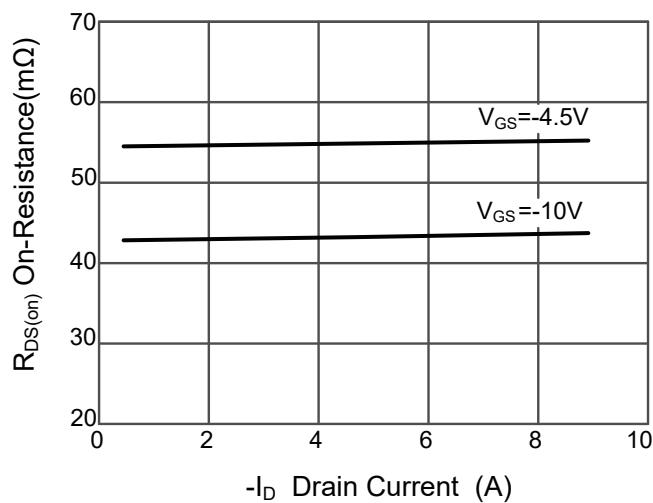
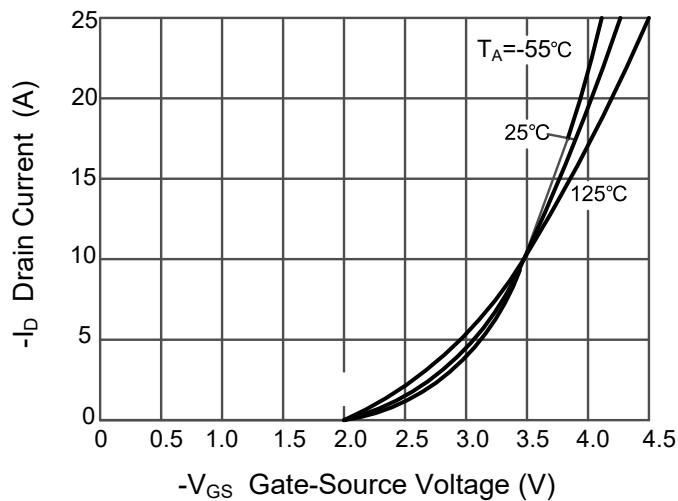
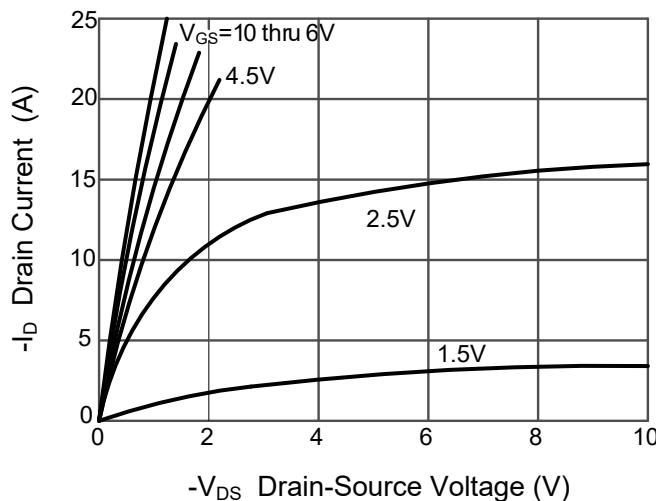
3. Pulse Test: Pulse width≤300μs, duty cycle≤2%



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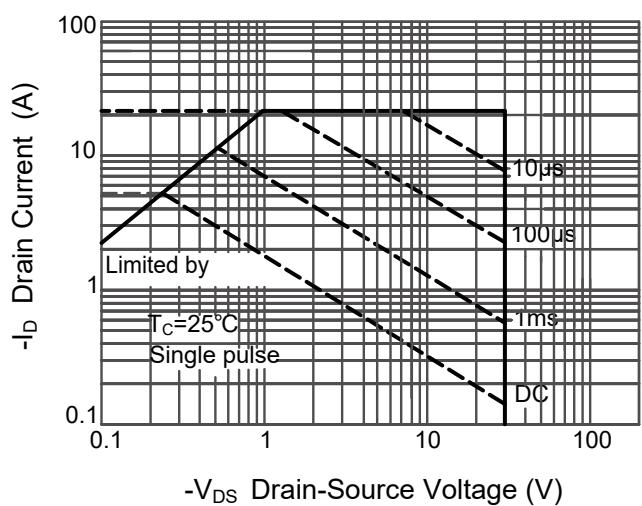
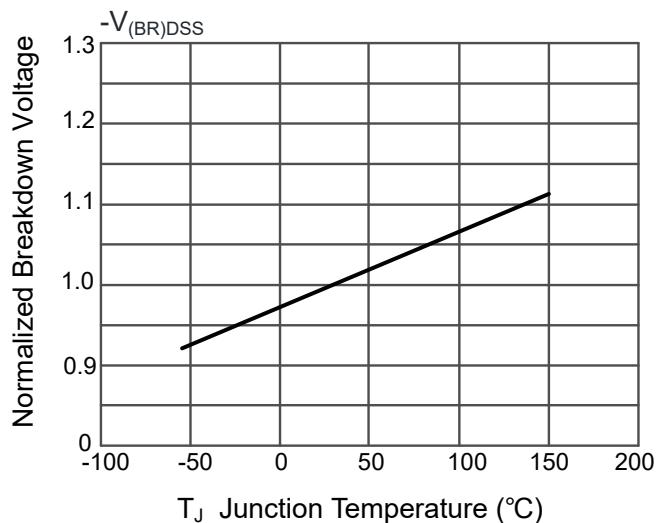
Typical Characteristic Curves





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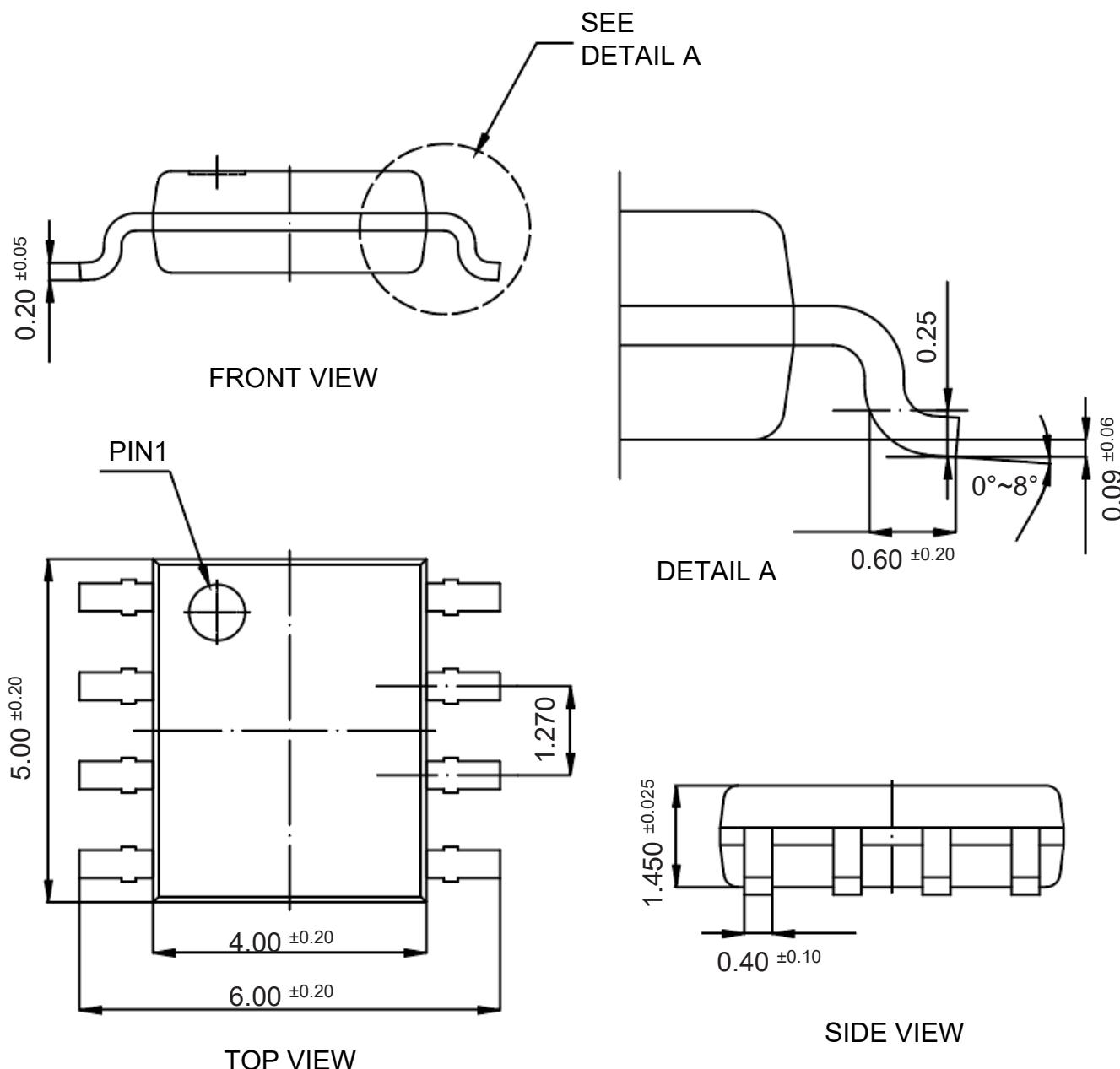
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Package Outline

SOP-8

Dimensions in mm



Ordering Information

Device	Package	Shipping
PJM05P30PA	SOP-8	4,000PCS/Reel&13inches